



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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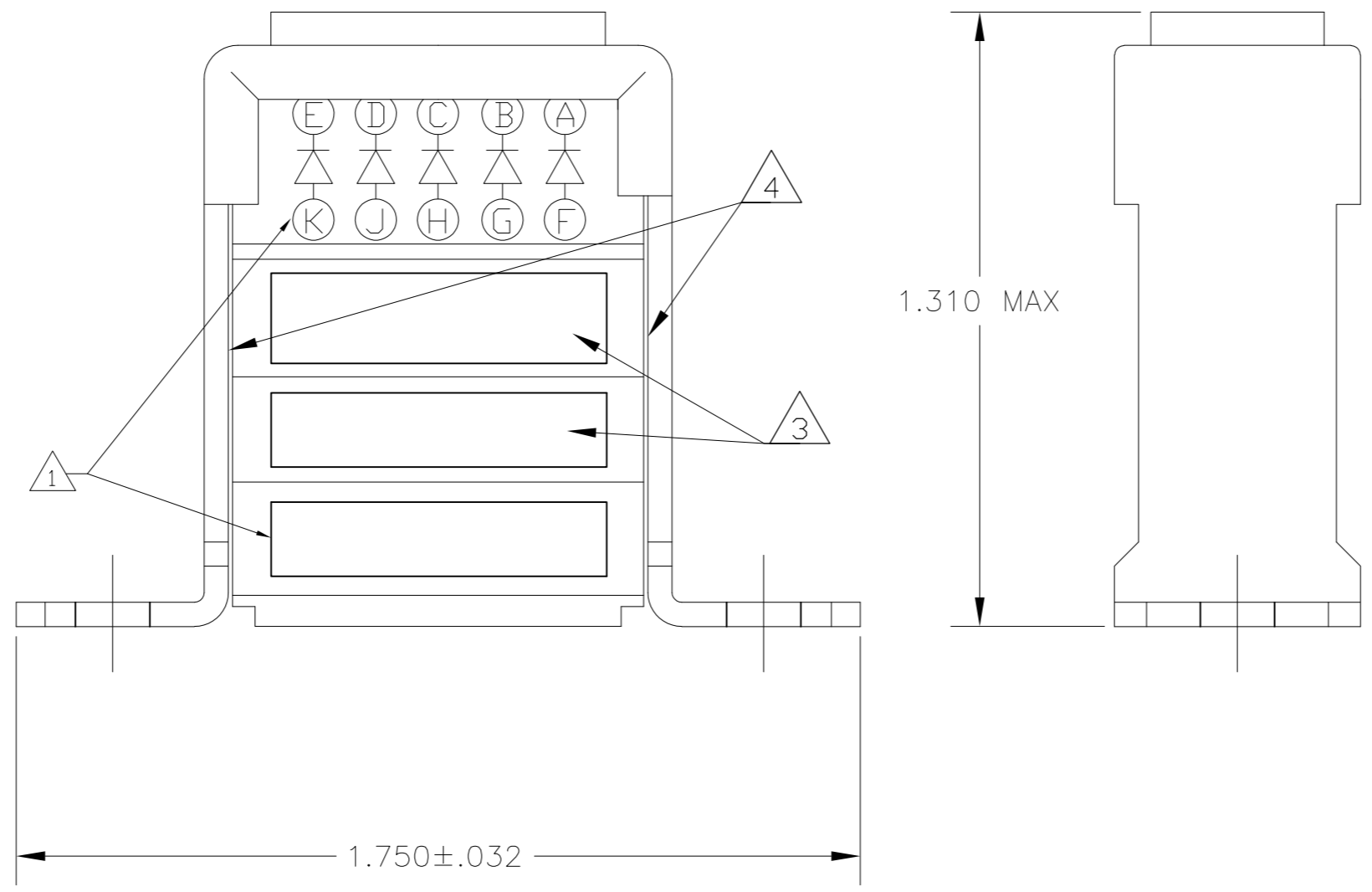
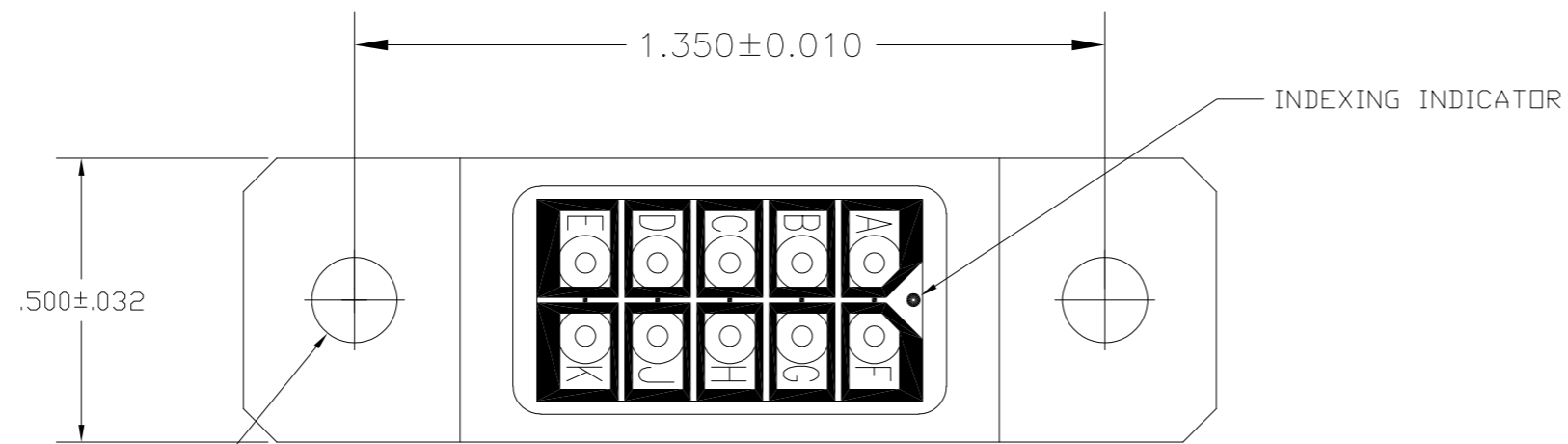
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| LOC | DIST | REVISIONS | | | | | |
|-----|------|-----------|-----|-----------------------|---------|-----|------|
| | | P | LTR | DESCRIPTION | DATE | DWN | APVD |
| DF | X5 | E | | REV PER ECO-11-022392 | 07NOV11 | PY | DE |



| DESCRIPTION | MATERIAL | FINISH |
|--------------------------|--|------------------------------|
| GROMMET | FLUROSILICONE RUBBER | COLOR: BLUE |
| MODULE ASSEMBLY | THERMOSET EPOXY | COLOR: BLACK |
| CONTACT, SOCKET ASSEMBLY | BERYLLIUM COPPER PER ASTM-B194 | GOLD PLATE PER MIL-G-45204 |
| CLIP CONTACT RETAINING | BERYLLIUM COPPER PER ASTM-B194 OR SST PER QQ-S-766 | NONE |
| BRACKET | AL-ALLOY 6061-T4 (.050 THK) | NICKEL PLATE PER MIL-C-26074 |
| CONTACTS | COPPER ALLOY PER MIL-C-32029/1 | GOLD PLATE PER MIL-G-45204 |
| SEALING PLUGS | F.E.P. PER MIL-P-19468 | COLOR: RED |

- 1 ASSEMBLIES ARE IDENTIFIED WITH "AMP", AMP P/N, DATE CODE, AND DIODE SCHEMATIC ON MODULE AT AREA SHOWN.
- 2 CONTACTS, INSERTION/EXTRACTION TOOL AND SEALING PLUGS SUPPLIED WITH MODULE ASSEMBLY.
- 3 MARK ASSEMBLY WITH CUSTOMER PART NO. 12079-20E-012 AT AREA SHOWN.
- 4 METAL MOUNTING BRACKET NOT BONDED TO MODULE ASSEMBLY.
- 5 DIODE MAY BE A COMMERCIAL DIODE THAT HAS BEEN SCREENED TO MEET THE REQUIREMENTS OF JANTX1N5552.
- 6 DIODE MAY BE A COMMERCIAL DIODE THAT HAS BEEN SCREENED TO MEET THE REQUIREMENTS OF JANTX1N5554.

| | | | | |
|-------------|---------|-------------|---------|----------|
| JANTX1N5554 | 6 | 2 | SIZE 20 | 591858-3 |
| JANTX1N5552 | 5 | | SIZE 20 | 591858-2 |
| JANTX1N5552 | 5 | 2 3 | SIZE 20 | 591858-1 |
| DIODE | REMARKS | DESCRIPTION | PART NO | |

THIS DRAWING IS A CONTROLLED DOCUMENT.

| | | | |
|---|------------------|--|--------------|
| DWN B. LATTUCA 09JAN2006 | | TE Connectivity | |
| CHK R. RYAN 08-10-93 | | NAME | |
| APVD R. RYAN 08-10-93 | | MODULE, FEED-BACK SIZE 20 ASSEMBLY TJ | |
| PRODUCT SPEC | | SIZE | CAGE CODE |
| APPLICATION SPEC | A2 | 00779 | C=591858 |
| MATERIAL SEE TABLE | WEIGHT | RESTRICTED TO | |
| TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ± - 1 PLC ± - 2 PLC ± - 3 PLC ± - 4 PLC ± - ANGLES ± - FINISH - | CUSTOMER DRAWING | SCALE 4:1 | SHEET 1 of 1 |